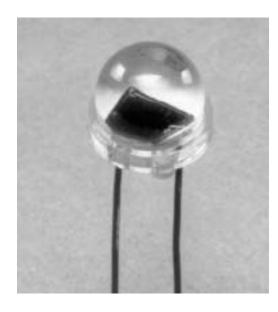
VTP Process Photodiodes

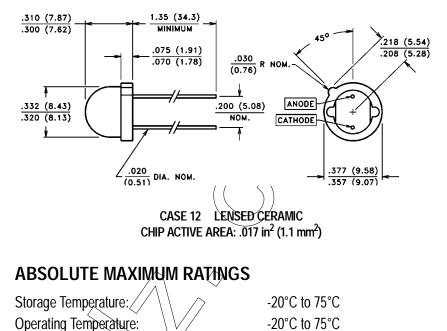
VTP1188S



PRODUCT DESCRIPTION

Large area planar silicon photodiode mounted on a two lead ceramic substrate. A clear molded lens is used to increase sensitivity. Low junction capacitance permits fast response time.

PACKAGE DIMENSIONS inch (mm)



ELECTRO-OPTICAL CHARACTERISTICS @ 25°C (See also VTP curves, pages 45-46)

SYMBOL	CHARACTERISTIC	TEST CONDITIONS -	VTP11188S			UNITS
			Min.	Тур.	Max.	UNITS
I _{SC}	Short Circuit Current	H = 100 fc, 2850 K		200		μΑ
TC I _{SC}	I _{SC} Temperature Coefficient	2850 K		.20		%/°C
I _{SC}	Short Circuit Current	100 µW/cm ² , 880 nm	13		25	μΑ
V _{OC}	Open Circuit Voltage	H = 100 fc, 2850 K		.33		mV
TC V _{OC}	V _{OC} Temperature Coefficient	2850 K		-2.0		mV/°C
۱ _D	Dark Current	H = 0, VR = 10 mV		3	30	nA
R _{SH}	Shunt Resistance	H = 0, V = 10 mV		67		GΩ
TC R _{SH}	R _{SH} Temperature Coefficient	H = 0, V = 10 mV		-11		%/°C
CJ	Junction Capacitance	H = 0, V =0 V		.18	.30	nF
λ_{range}	Spectral Application Range		400		1100	nm
λ _p	Spectral Response - Peak			925		nm
S _R	Sensitivity	@ Peak		.55		A/W